

RF6L025BG

Nch 60V 2.5A Power MOSFET

V _{DSS}	60V
R _{DS(on)} (Max.)	91mΩ
I _D	±2.5A
P _D	1W

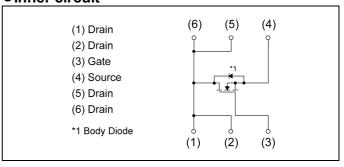
Features

- 1) Low on resistance
- 2) Small surface mount package (TUMT6)
- 3) Pb-free lead plating; RoHS compliant
- 4) Halogen Free

SOT-363T TUMT6

●Inner circuit

Outline



Packaging specifications

or dokaging opcomoduono					
	Packing	Embossed Tape			
	Reel size (mm)	180			
Туре	Tape width (mm)	8			
	Quantity (pcs)	3000			
	Taping code	TCR			
	Marking	KD			

Application

Switching

Motor drives

DC/DC converter

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	60	V
Continuous drain current	I _D	±2.5	А
Pulsed drain current	I _{DP} *1	±10	А
Gate - Source voltage	V _{GSS}	±20	V
Douger discipation	P _D *2	1	W
Power dissipation	P _D *3	0.91	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Dorameter	Symbol	Values			l leit
Parameter		Min.	Тур.	Max.	Unit
Thermal registeres innetion, ambient	R _{thJA} *2	-	-	125	°C/W
Thermal resistance, junction - ambient	R _{thJA} *3	-	-	137	°C/W

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol Conditions -			Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{GS} = 0V$, $I_D = 1mA$	60	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	38.9	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	1	-	1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	1	1	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 1mA$	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = 1mA referenced to 25°C	-	-4.7	-	mV/°C
Static drain - source	D *4	V _{GS} = 10V, I _D = 2.5A	-	70	91	m0
on - state resistance	R _{DS(on)} *4	$V_{GS} = 4.5V, I_D = 2.5A$	ı	100	140	mΩ
Gate resistance	R_G	-	1	2.7	-	Ω
Forward Transfer Admittance	Y _{fs} *4	$V_{DS} = 5V, I_{D} = 2.5A$	1.3	-	-	S

^{*1} Pw \leq 10 μ s, Duty cycle \leq 1%

^{*2} Mounted on a ceramic board (30×30×0.8mm)

^{*3} Mounted on a FR4 (25×25×0.8mm)

^{*4} Pulsed

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions		Unit			
Parameter	Symbol	bol Conditions		Тур.	Max.	Urill	
Input capacitance	C _{iss}	V _{GS} = 0V	-	135	-		
Output capacitance	C _{oss}	V _{DS} = 30V	-	38	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	6	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 30V, V_{GS} = 10V$	1	5.3	1		
Rise time	t _r *4	I _D = 1.25A	1	4.8	1	no	
Turn - off delay time	t _{d(off)} *4	$R_L \simeq 24\Omega$		13	-	ns	
Fall time	t _f *4	$R_G = 10\Omega$	-	3.1	-		

• Gate charge characteristics $(T_a = 25^{\circ}C)$

Darameter	Cymahal	Conditions		Values			l limit
Parameter	Symbol			Min.	Тур.	Max.	Unit
Total gate charge	O *4		V _{GS} = 10V	-	3.1	-	
Total gate charge	Q_{g} .	Q_g^{*4} $V_{DD} \simeq 30V$		-	1.7	-	5 C
Gate - Source charge	Q _{gs} *4	$I_D = 2.5A$	V _{GS} = 4.5V	-	0.9	-	nC
Gate - Drain charge	Q _{gd} *4			-	0.3	-	

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Darameter	Cumbal	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Continuous forward current	I _S	T = 25°C	1	-	0.83	Α
Pulse forward current	I _{SP} *1	T _a = 25°C	-	-	10	Α
Forward voltage	V _{SD} *4	$V_{GS} = 0V, I_S = 0.83A$	-	-	1.2	V
Reverse recovery time	t _{rr} *4	I _S = 2.5A, V _{GS} =0V	-	23	-	ns
Reverse recovery charge	Q _{rr} *4	di/dt = 100A/μs	-	20	-	nC

Fig.1 Power Dissipation Derating Curve

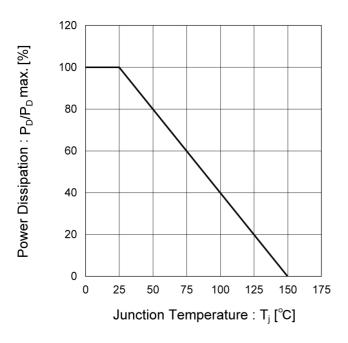
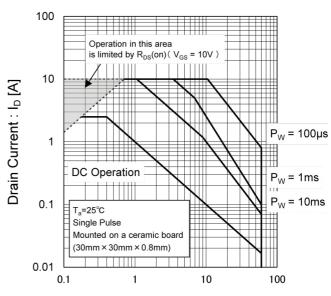


Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : V_{DS} [V]

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

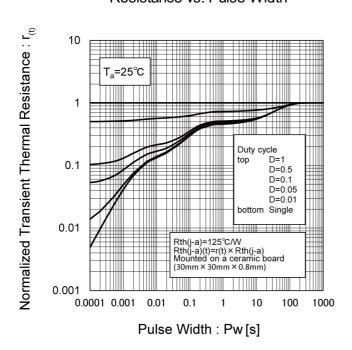
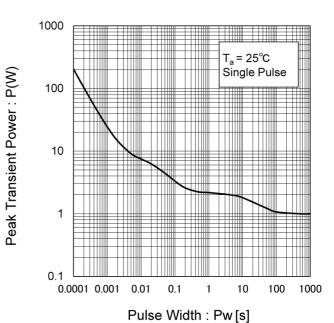


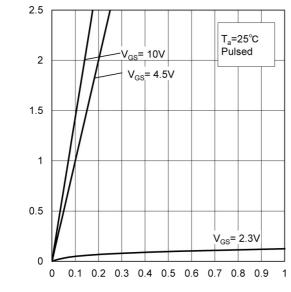
Fig.4 Single Pulse Maximum Power Dissipation



Drain Current : I_D [A]

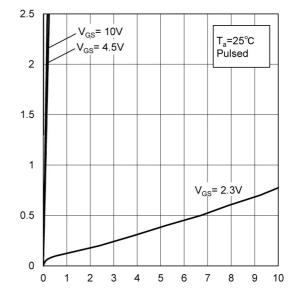
• Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)



Drain - Source Voltage : V_{DS} [V]

Fig.6 Typical Output Characteristics(II)



Drain Current : I_D [A]

Drain - Source Voltage : V_{DS} [V]

Fig.7 Normalized Breakdown Voltage vs. Junction Temperature

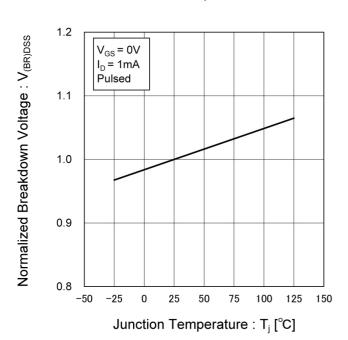


Fig.8 Typical Transfer Characteristics

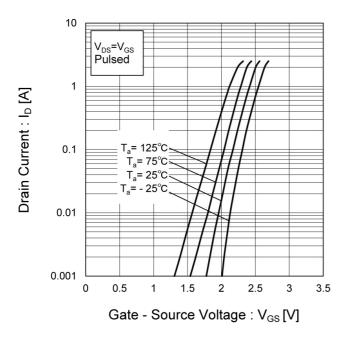
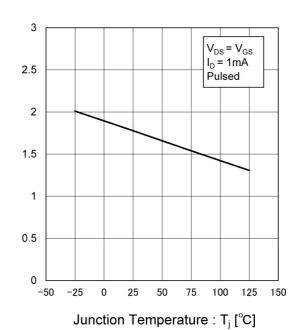


Fig.9 Gate Threshold Voltage vs.
Junction Temperature



Gate Threshold Voltage: VGS(th) [V]

Fig.10 Forward Transfer Admittance vs.
Drain Current

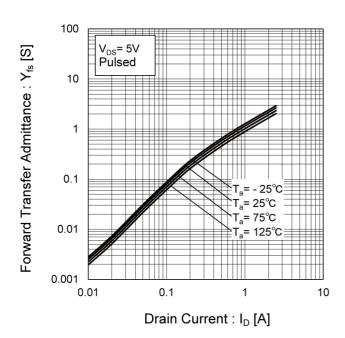


Fig.11 Drain Current Derating Curve

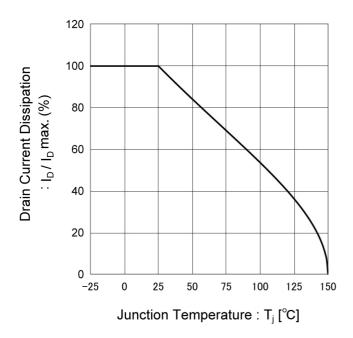


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

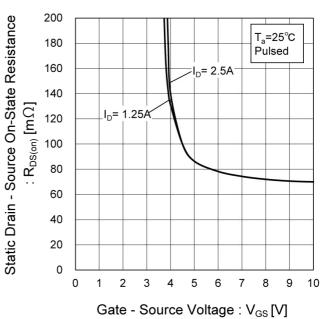


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

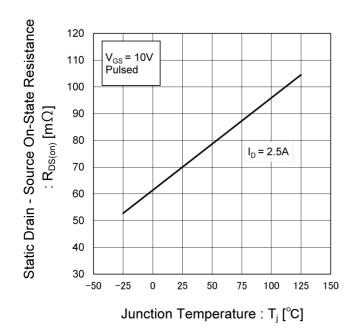




Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

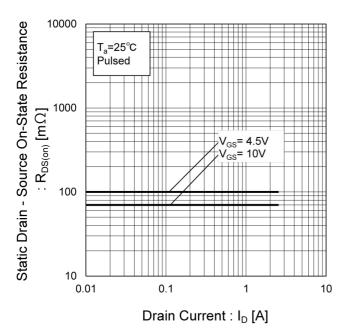


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

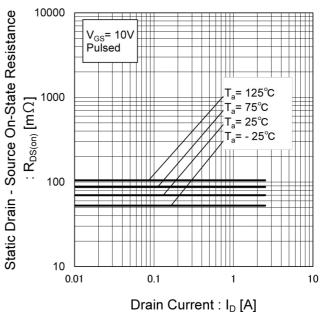


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

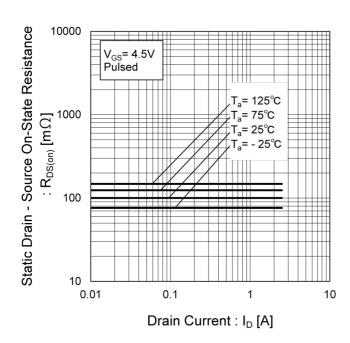


Fig.17 Typical Capacitances vs.

Drain - Source Voltage

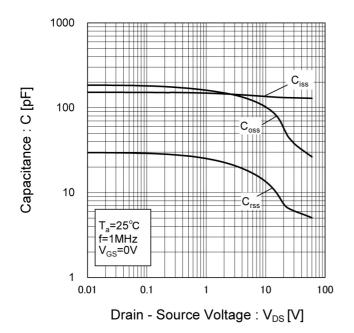


Fig.18 Switching Characteristics

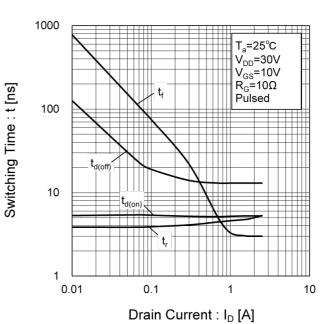


Fig.19 Typical Gate Charge

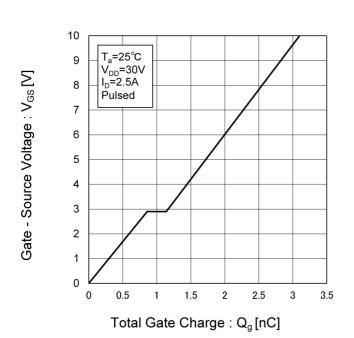
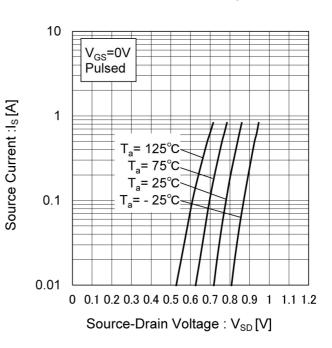


Fig.20 Source Current vs.

Source Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

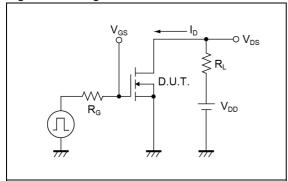


Fig.2-1 Gate Charge Measurement Circuit

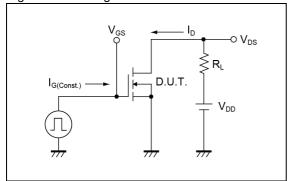


Fig.1-2 Switching Waveforms

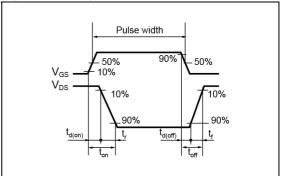
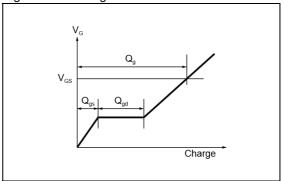


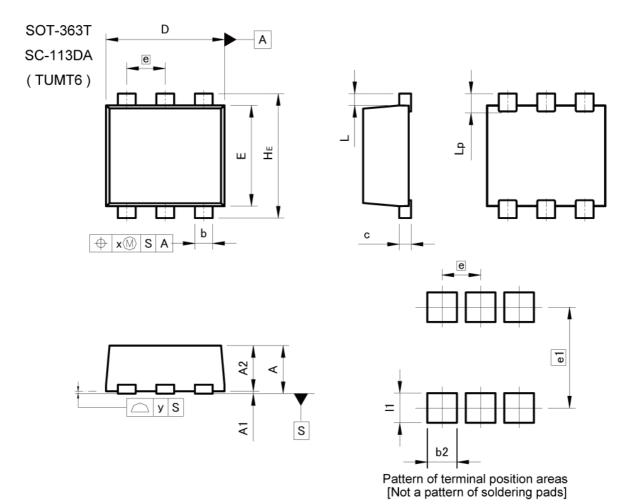
Fig.2-2 Gate Charge Waveform



Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

Dimensions



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	-	0.85	_	0.033
A1	0.00	0.05	0.000	0.002
A2	0.72	0.82	0.028	0.032
b	0.25	0.40	0.010	0.016
С	0.12	0.22	0.005	0.009
D	1.90	2.10	0.075	0.083
E	1.60	1.80	0.063	0.071
е	0.	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.5	20	0.008	
Lp	-	0.40	_	0.016
х		0.10		0.004
У	-	0.10	-	0.004

	NATI TNA	ETEDO	TNIO	LIFO
DIM	MILIM	ETERS	INC	HES
DIW	MIN	MAX	MIN	MAX
b2		0.50	-	0.020
e1	1.	70	0.0	67
11	-1	0.50	_	0.020

Dimension in mm/inches

Notice

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JÁPAN	USA	EU	CHINA
CLASSⅢ	ОГУООШ	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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